

PATENT ASSIGNMENT

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SUBMISSION TYPE:		NEW ASSIGNMENT
NATURE OF CONVEYANCE:		ASSIGNMENT
CONVEYING PARTY DATA		
Name		Execution Date
Yongchul Ahn		09/09/2003
Kaichiu Wong		09/09/2003
RECEIVING PARTY DATA		
Name:	Cypress Semiconductor Corporation	
Street Address:	3901 North First Street	
City:	San Jose	
State/Country:	CALIFORNIA	
Postal Code:	95134-1599	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	10436411	
CORRESPONDENCE DATA		
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NAME OF SUBMITTER:	Paul E. Rauch Ph.D.	
Total Attachments: 2		
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source=CYP01-049-CIP-US DOCUMENTS FOR ON-LINE ASSIGNMENT#page2.tif		

OP \$40.00 10436411

PM99032

Docket Number: 09799940-0130

ASSIGNMENT

WHEREAS, Yongchul Ahn, Kaichiu Wong and Venuka Jayatilaka referred to as ASSIGNORS, have invented a certain invention entitled: "Isolation Technology for Submicron Semiconductor Devices"; and

WHEREAS, CYPRESS SEMICONDUCTOR CORPORATION, incorporated in the State of Delaware, with a principal place of business at 3901 North First Street, San Jose, California 95134-1599, hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in, to and under said invention and the United States Letters Patent to be obtained therefor:

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN:

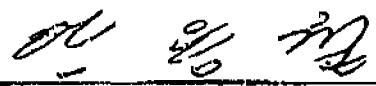
Be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, the ASSIGNORS hereby sell, assign and transfer to ASSIGNEE the full and exclusive right, title and interest to said invention and all Letters Patent of the United States to be obtained therefor on said applications or any non-provisional, continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted.

ASSIGNORS also assign all of their rights, title and interest in and to said invention in all foreign countries, and all applications for Letters Patent which may evolve therefrom, including the right to claim International Convention priority.

ASSIGNORS hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

ASSIGNORS further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said applications, said invention and said Letters Patent as may be known and accessible to ASSIGNORS, and ASSIGNORS will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for obtain, maintain and enforce said applications, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

Date: 09/09/03

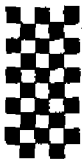

Yongchul Ahn

Date: _____

Kaichiu Wong

Date: _____

Venuka Jayatilaka



Docket Number: 09799940-0130

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Date: _____

Yongchul Ahn

Date: 9/9/03

Kaichiu Wong

Date: _____

Venuka Jayatilaka

PATENT